TMS320C66x high-performance multicore DSPs for video surveillance

Delivering industry-best performance-per-watt, scalable multicore DSPs to enable advanced analytics at the edge and in the server



Texas Instruments' TMS320C66x multicore DSPs provide real-time performance to implement advanced analytics for surveillance and security applications. With a scalable roadmap that has both low-power and high-performance targeted devices, these surveillance and security applications include equipment such as:

- Smart IP cameras
- Digital video recorders (DVRs)
- Networked video recorders (NVRs)
- Video analytics servers

The needs of businesses, governments, financial institutions and transportation hubs, to name a few, are driving new uses for video surveillance and security systems beyond crime prevention and into areas of information gathering, asset management, safety and risk mitigation. This is forcing the end equipment

Multicore Navigator AccelerationPacs 2x VCP2 TCP3d Peripherals & 10 Memory Subsystem Multicore shared memory controller (MSMC) Ethernet McBSP DDR3-32b TeraNet SRIO x4 PCIe x2 Shared memory 1MB FMIF 16 I2C SPI UART lyperLink

to evolve through increased analytics, pushing the need for the additional processing power provided by TI's multicore devices.

To meet these needs, video surveillance and security manufacturers can choose a range of solutions from TI's scalable family of multicore DSPs, including the TMS320C667x devices that have from one to eight C66x DSP cores, and the TMS320C665x devices that have been designed for low power and have either a single- or dual-C66x DSP. The breadth of TI's multicore DSP portfolio enables the development for surveillance applications that keep up with the demanding needs of the market.

Adding intelligence to the edge

The need to add analytics to the edge, or at the cameras, comes with its own set of challenges. At the edge, size and power restrictions exist which have traditionally limited the addition of

higher-level analytics. Tl's new TMS320C6654, TMS320C6655 and TMS320C6657 multicore devices are power optimized and deliver high performance along with high-speed peripherals in a small 21×21-mm package (Figure 1). These devices are also in a lower profile (2.99-mm height) package, enabling minimal overall product packaging size and weight.

The full-featured dual-core C6657 DSP uses just 3.5 W at 1 GHz while the more specialized single-core C6654 DSP needs less than 2 W at 850 MHz.

Key Features

- Family of high-performance, pincompatible C667x DSPS comprising of one, two, four or eight C66x cores running at 1.25 GHz and delivering up to 320 GMACS/160 GFLOPS of fixed- and floating-point performance.
- Family of power-optimized, pin-compatible C665x DSPs comprising of single or dual C66x cores running at up to 1.25 GHz and delivering up to 80 GMACS/40 GFLOPS of fixed- and floating-point performance.
 - TMS320C6657 @ 1 GHz 3.5 W
 - TMS320C6655 @ 1 GHz 2.5 W
 - TMS320C6654 @ 850 MHz <2 W
 - Package: 21×21-mm FC-BGA
- Large on-chip memory and multiple highspeed interfaces
- Free multicore software development kit (MCSDK) enabling easier programming
- Low-cost evaluation modules starting at U.S. \$349
- Extensive third-party network providing hardware and software support

These devices have both fixed-and floating-point capability with the 1.25-GHz C6657 DSP delivering 80 GMACS, 40 GFLOPS of processing, enabling intelligence at the edge with advanced features such as stereo-vision based algorithms or the tracking of multiple simultaneous events including:

- Motion detection
- Trip zone detection

▲ Figure 1. TMS320C6657/55 block diagram

- Object counting
- Object recognition
- Vehicle detection
- License plate recognition
- Behavior analysis

Improving recorders and servers

DVRs, NVRs and video analytic servers are, similar to the smart cameras at the edge, looking to add more advanced analytics in a cost- and power-efficient way. TI's TMS320C6674 and TMS320C6678 multicore DSPs provide, respectively, four or eight C66x fixed- and floating-point DSP cores. The flagship C6678 DSP, the industry's highestperforming multicore DSP solution, features eight 1.25-GHz cores, effectively providing a 10-GHz DSP delivering 320 GMACS, 160 GFLOPS of combined fixed- and floating-point performance. This benchmarkbusting performance enables developers to simultaneously run multiple advanced analytics in their DVRs, NVRs and servers on more streams of higher-resolution video.

Based on the same C66x cores, the C667x and C665x multicore DSPs are code compatible with each other, as well as backwards compatible to previous generations, providing a scalable solution base from previous generations of surveillance and security equipment to today's advanced smart cameras and to DVRs, NVRs and servers, ensuring maximal code reuse.

By leveraging the DSP programmability, processing performance, high-speed peripherals and support for all major multimedia codecs, developers can design differentiated products with customized features to meet the evolving needs of the video surveillance and security market.

Easing development with multicore software and tools

TI offers optimized libraries, support for the OpenMP programming model, SYS/BIOS™ real-time operating system and Linux™ support in a free multicore software development kit (MCSDK) to developers working with its C66x multicore DSPs. The free IMGLIB and VLIB optimized libraries provide common building blocks used in many video surveillance and security algorithms, and the DSPLIB and MATHLIB libraries aide in developing optimized real-time signal processing. TI's MCSDK also includes demo software showing a multicore image-processing example and a fast Fourier transform (FFT) based signal-processing example.

Tl also offers all major multimedia codecs on the C66x architecture. Tl codecs are free, come with production licensing and are available for download now. All are production tested for easy integration.

TI provides a full suite of best-in-class Eclipse-based development and debug tools for the C667x and C665x devices, including a new C compiler, an assembly optimizer to



▲ Figure 2. TMS320C6678 Lite Evaluation Module

simplify programming and scheduling, and a Windows[®] debugger interface for visibility into source code execution. Ti's compiler generates highly efficient code that is "first pass efficient" so there is less need to optimize it. Ti's debug tools help developers to visualize problems and resolve them quickly, helping designers get products to the field faster while saving development resources.

To further ease development, TI offers low-cost evaluation modules (EVMs) for each of these devices. The C6678 Lite EVM starts at U.S. \$399 (Figure 2) and the C6657 Lite EVM starts at U.S. \$349. Both EVMs include TI's MCSDK and Code Composer Studio™ integrated development environment, allowing programmers to quickly come up to speed on the TMS320C66x platform.

For additional information on TI's multicore DSPs, software and low-cost EVMs, please visit **www.ti.com/multicore**.

The platform bar, Code Composer Studio, E2E and SYS/BIOS are trademarks of Texas Instruments. All other trademarks are the property of their respective owners.



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components which meet ISO/TS16949 requirements, mainly for automotive use. Components which have not been so designated are neither designed nor intended for automotive use; and TI will not be responsible for any failure of such components to meet such requirements.

Products Applications

Audio Automotive and Transportation www.ti.com/automotive www.ti.com/audio **Amplifiers** amplifier.ti.com Communications and Telecom www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers DI P® Products Consumer Electronics www.dlp.com www.ti.com/consumer-apps

DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface Medical www.ti.com/medical interface.ti.com Logic logic.ti.com Security www.ti.com/security

Power Mgmt <u>power.ti.com</u> Space, Avionics and Defense <u>www.ti.com/space-avionics-defense</u>

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

OMAP Applications Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>